



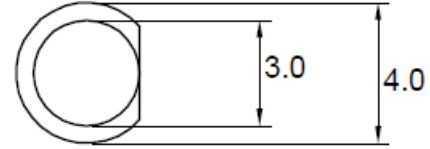
American Opto Plus LED Corp.

L314L-UYC

3mm Yellow LED Lamp

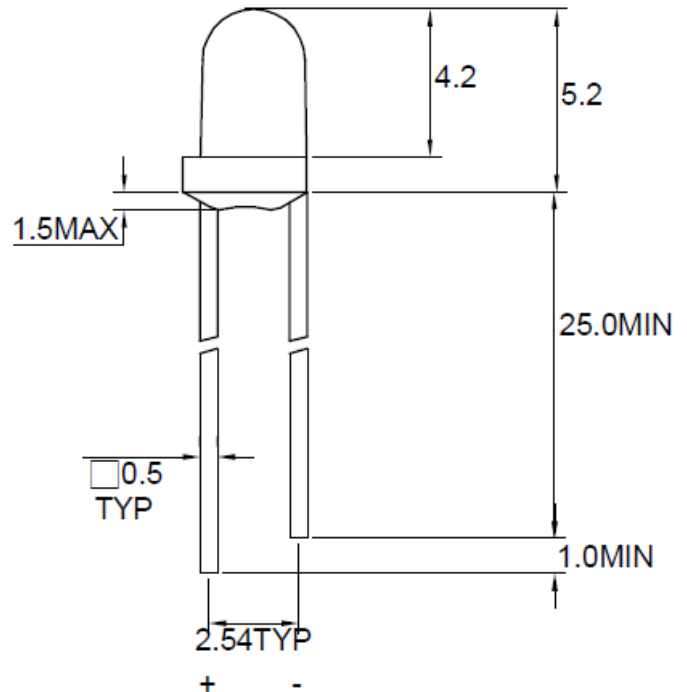
DESCRIPTION

- Round Type
- 3mm Diameter
- Lens Color: Water Clear
- With Flange
- Solder leads without standoffs



FEATURES

- Emitted Color: Yellow
- Technology: AlGaInP/GaP
- Viewing Angle: 30°



NOTES:

1. All dimensions are in millimeters tolerance is ± 0.25 mm unless otherwise noted;

| Part Number | Material | Lens Color | |
|-------------|-------------|------------|-------------|
| | | Emitted | Lens |
| L314L-UYC | AlGaInP/GaP | Yellow | Water Clear |



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ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|----------------------------------------|------------------|----------|------|
| Forward Current | I _F | 50 | mA |
| Peak Forward Current Duty 1/10 @ 10KHz | I _{FP} | 100 | mA |
| Reverse Voltage | V _R | 5 | V |
| Power Dissipation | P _d | 130 | mW |
| Electrostatic Discharge | ESD | 2000 | V |
| Operating temperature range | T _{opr} | -40~+85 | °C |
| Storage temperature range | T _{stg} | -40~+100 | °C |

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
|---------------------|----------------|----------------------|------|------|-----|------|
| Reverse Current | I _R | V _R =5V | -- | -- | 10 | μA |
| Forward Voltage | V _F | I _F =20mA | 1.7 | -- | 2.6 | V |
| Luminous Intensity | I _v | | 1100 | 1800 | -- | mcd |
| Dominant Wavelength | λ _P | | -- | 590 | -- | nm |
| Spectral Halfwidth | Δλ | | -- | 20 | -- | nm |
| Viewing Angle | 2θ ½ | | -- | 30 | -- | deg |

Note:

1. The forward voltage data did not include ±0.1V testing tolerance.
2. The luminous intensity data did not include ±15% testing tolerance.



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TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVE

Fig.1 Forward Current vs. Forward Voltage

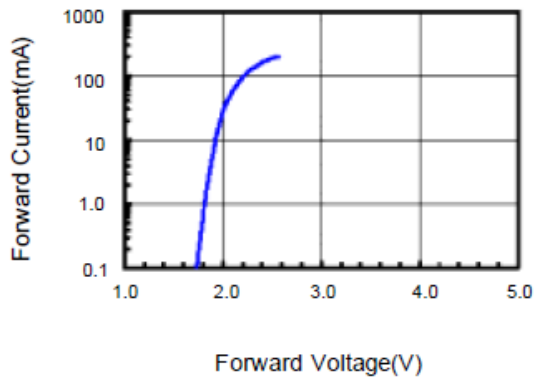


Fig.2 Relative Intensity vs. Forward Current

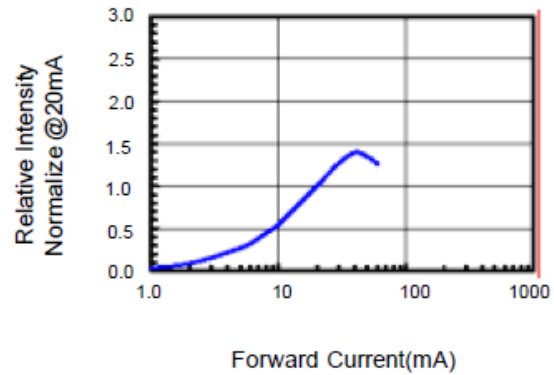


Fig.3 Forward Voltage vs. Temperature

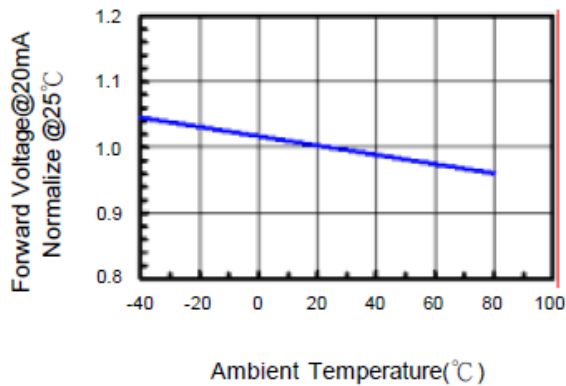


Fig.4 Relative Intensity vs. Temperature

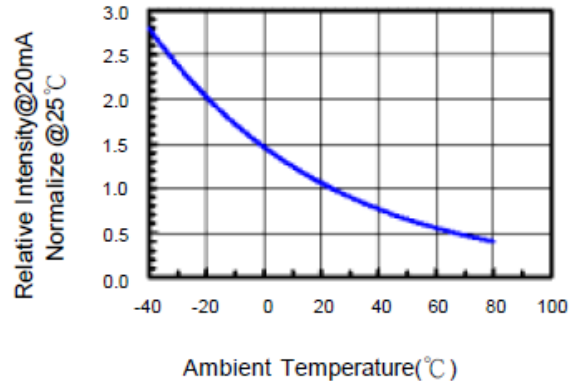


Fig.5 Relative Intensity vs. Wavelength

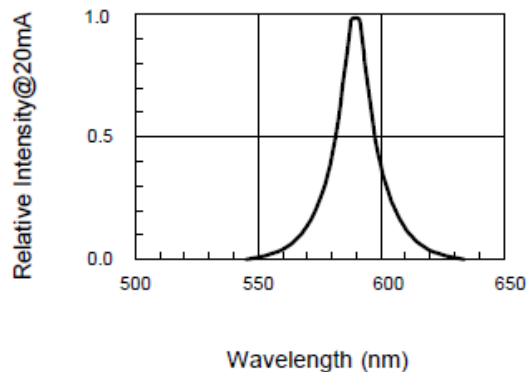
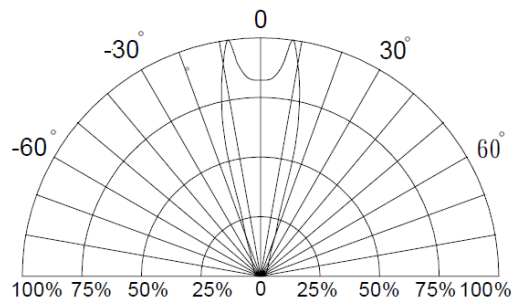


Fig.6 Directivity Radiation





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SOLDERING CONDITION (Pb-Free)

1. Iron:

Soldering Iron: 30W Max

Temperature 350° C Max

Soldering Time: 3 Seconds Max (One time only)

Distance: 2mm Min (From solder joint to body)

2. Wave Soldering Profile

Dip Soldering

Preheat: 120° C Max

Preheat time: 60 seconds Max

Ramp-up

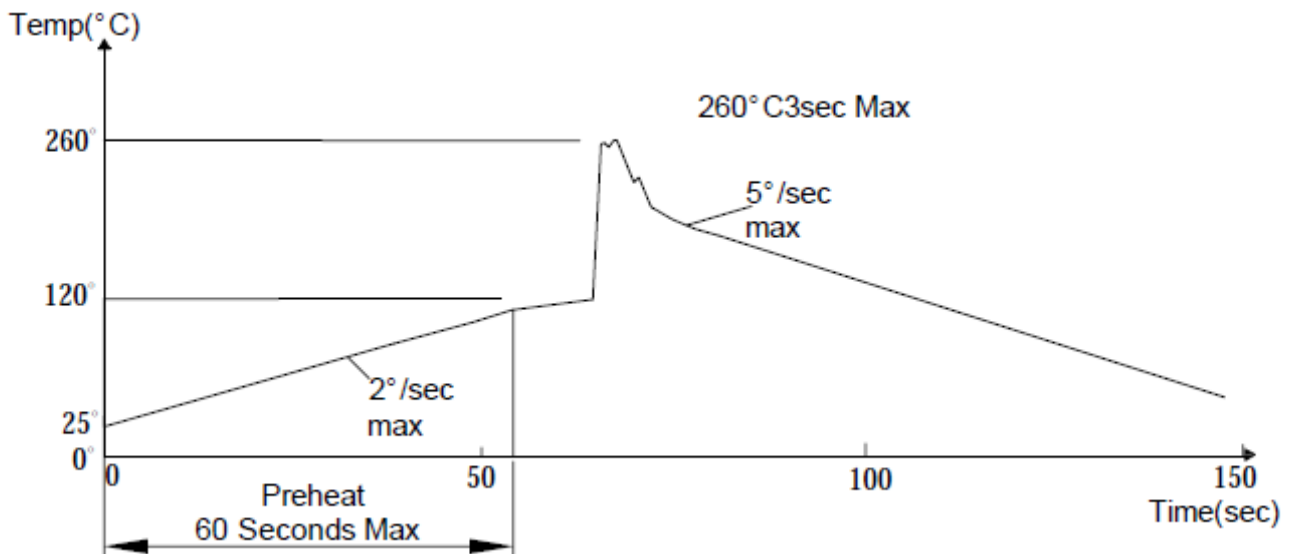
2° C/sec (max)

Ramp-Down: -5° C/sec (max)

Solder Bath: 260° C Max

Dipping Time: 3 seconds Max

Distance: 2mm Min (From solder joint to body)



Note:

1. Wave solder should not be made more than one time.
2. You can just only select one of the soldering conditions as above.



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RELIABILITY TEST

| Test Item | Test Condition | Description | Reference Standard |
|-------------------------------------|------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------|
| Operating Life Test | 1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs) | This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed. | MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1 |
| High Temperature Storage Test | 1.Ta=105 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of high temperature for hours. | MIL-STD-883:1008 JIS C 7021: B-10 |
| Low Temperature Storage Test | 1.Ta=-40 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of low temperature for hours. | JIS C 7021: B-12 |
| High Temperature High Humidity Test | 1.Ta=65 °C±5°C 2.RH=90 %~95 % 3.t=240hrs ±2hrs | The purpose of this test is the resistance of the device under tropical for hours. | MIL-STD-202:103B JIS C 7021: B-11 |
| Thermal Shock Test | 1.Ta=105 °C±5°C & -40 °C±5°C (10min) (10min) 2.total 10 cycles | The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature. | MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011 |
| Solder Resistance Test | 1.T.Sol=260 °C±5°C 2.Dwell time= 10 ±1sec. | This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire. | MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1 |
| Solderability Test | 1.T.Sol=230 °C±5°C 2.Dwell time=5 ±1sec | This test intended to see soldering well performed or not. | MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2 |